SN65C1167, SN75C1167, SN65C1168, SN75C1168 DUAL DIFFERENTIAL DRIVERS AND RECEIVERS

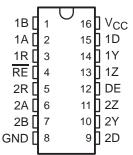
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- Meet or Exceed Standards TIA/EIA-422-B and ITU Recommendation V.11
- BiCMOS Process Technology
- Low Supply-Current Requirements: 9 mA Max
- Low Pulse Skew
- Receiver Input Impedance . . . 17 kΩ Typ
- Receiver Input Sensitivity . . . ±200 mV
- Receiver Common-Mode Input Voltage Range of -7 V to 7 V
- Operate From Single 5-V Power Supply
- Glitch-Free Power-Up/Power-Down Protection
- Receiver 3-State Outputs Active-Low Enable for SN65C1167 and SN75C1167 Only
- Improved Replacements for the MC34050 and MC34051

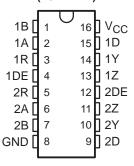
description/ordering information

The SN65C1167, SN75C1167, SN65C1168, and SN75C1168 dual drivers and receivers are integrated circuits designed for balanced transmission lines. The devices meet TIA/EIA-422-B and ITU recommendation V.11.

SN65C1167 ... DB OR NS PACKAGE SN75C1167 ... DB, N, OR NS PACKAGE (TOP VIEW)



SN65C1168 ... N, NS, OR PW PACKAGE SN75C1168 ... DB, N, NS, OR PW PACKAGE (TOP VIEW)



ORDERING INFORMATION

TA	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP (N)	Tube	SN75C1167N	SN75C1167N
	SOP (NS)	Tape and reel	SN75C1167NSR	75C1167
	SSOP (DB)	Tape and reel	SN75C1167DBR	CA1167
000 to 7000	PDIP (N)	Tube	SN75C1168N	SN75C1168N
0°C to 70°C	SOP (NS)	Tape and reel	SN75C1168NSR	75C1168
	SSOP (DB)	Tape and reel	SN75C1168DBR	CA1168
	TCCOD (DW)	Tube	SN75C1168PW	CA4460
	TSSOP (PW)	Tape and reel	SN75C1168PWR	CA1168
	SOP (NS)	Tape and reel	SN65C1167NSR	65C1167
	SSOP (DB)	Tape and reel	SN65C1167DBR	CB1167
–40°C to 85°C	PDIP (N)	Tube	SN65C1168N	SN65C1168N
	SOP (NS)	Tape and reel	SN65C1168NSR	65C1168
	TSSOP (PW)	Tube	SN65C1168PW	CB1168
	1330F (FW)	Tape and reel	SN65C1168PWR	CD1100

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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SN65C1167, SN75C1167, SN65C1168, SN75C1168 DUAL DIFFERENTIAL DRIVERS AND RECEIVERS

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description/ordering information (continued)

The SN65C1167 and SN75C1167 combine dual 3-state differential line drivers and 3-state differential line receivers, both of which operate from a single 5-V power supply. The driver and receiver have active-high and active-low enables, respectively, which can be connected together externally to function as direction control. The SN65C1168 and SN75C1168 drivers have individual active-high enables.

Function Tables

EACH DRIVER

INPUT	ENABLE	OUTF	PUTS
D	DE	Υ	Z
Н	Н	Н	L
L	Н	L	Н
Х	L	Z	Z

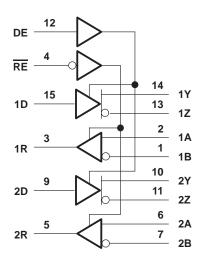
SN75C1167, EACH RECEIVER

DIFFERENTIAL INPUTS A – B	ENABLE RE	OUTPUT R
V _{ID} ≥ 0.2 V	L	Н
$-0.2 \text{ V} < \text{V}_{\text{ID}} < 0.2 \text{ V}$	L	?
$V_{ID} \le -0.2 V$	L	L
X	Н	Z
Open	L	Н

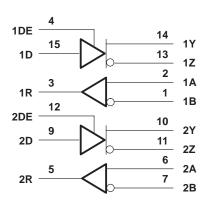
H = high level, L = low level, ? = indeterminate, X = irrelevant, Z = high impedance (off)

logic diagram (positive logic)

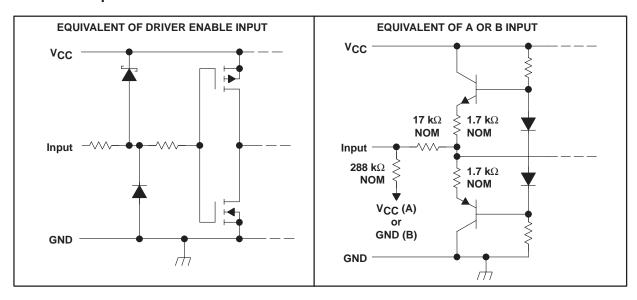
SN65C1167/SN75C1167



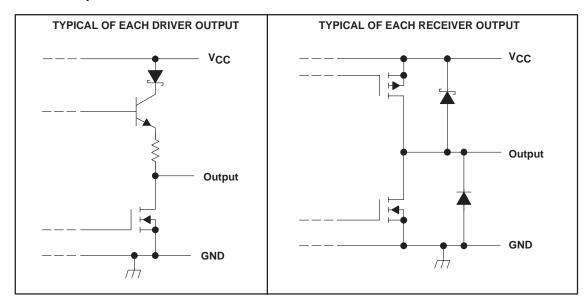
SN65C1168, SN75C1168



schematics of inputs



schematics of outputs



SN65C1167, SN75C1167, SN65C1168, SN75C1168 DUAL DIFFERENTIAL DRIVERS AND RECEIVERS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC} (see Note 1)		–0.5 V to 7 V
Input voltage range, V _I		. -0.5 V to V_{CC} + 0.5 V
Input voltage range, V _I (A or B, Receiver)		–11 V to 14 V
Differential input voltage range, V _{ID} , Receiver (see No	te 2)	–14 V to 14 V
Output voltage range, V _O , Driver		–5 V to 7 V
Clamp current range, I _{IK} or I _{OK} , Driver		±20 mA
Output current range, I _O , Driver		±150 mA
Supply current, I _{CC}		200 mA
GND current		
Output current range, I _O , Receiver		±25 mA
Operating virtual junction temperature		150°C
Package thermal impedance, θ_{JA} (see Notes 3 and 4):	DB package	82°C/W
•••	N package	67°C/W
	NS package	64°C/W
	PW package	108°C/W
Storage temperature range, T _{stq}		65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values except differential input voltage are with respect to the network GND.
 - 2. Differential input voltage is measured at the noninverting terminal with respect to the inverting terminal.
 - 3. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) T_A)/\theta_{JA}$. Selecting the maximum of 150°C can affect reliability.
 - 4. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

				MIN	NOM	MAX	UNIT
Vcc	V _{CC} Supply voltage			4.5	5	5.5	V
V _{IC}	Common-mode input voltage (see Note 5)	Receiver				±7	٧
V_{ID}	Differential input voltage	Receiver	Receiver			±7	V
VIH	High-level input voltage	Except A, B		2			V
VIL	Low-level input voltage	Except A, B				8.0	V
	LP ale level autout access at	Receiver				-6	4
ЮН	High-level output current	Driver				-20	mA
		Receiver				6	
IOL	Low-level output current	Driver				20	mA
T. On another first six terms are true		SN75C1167, SN75C1168	0		70	°C	
1A	T _A Operating free-air temperature		SN65C1167, SN65C1168	-40		85	-0

NOTE 5: Refer to TIA/EIA-422-B for exact conditions.



DRIVER SECTION

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

	PARAMETER TEST CONDITIONS		MIN	TYP†	MAX	UNIT		
VIK	Input clamp voltage	I _I = -18 mA					-1.5	V
Vон	High-level output voltage	V _{IH} = 2 V,	$V_{IL} = 0.8 V$,	$I_{OH} = -20 \text{ mA}$	2.4	3.4		V
VOL	Low-level output voltage	V _{IH} = 2 V,	V _{IL} = 0.8 V,	$I_{OL} = 20 \text{ mA}$		0.2	0.4	V
VOD1	Differential output voltage	IO = 0 mA			2		6	V
Vod2	Differential output voltage				2	3.1		V
Δ V _{OD}	Change in magnitude of differential output voltage	R_L = 100 Ω, See Figure 1 and Note 5				±0.4	V	
Voc	Common-mode output voltage					±3	V	
Δ VOC	Change in magnitude of common-mode output voltage						±0.4	V
	Output assert with a second of (as Alata O)	V 0V	VO = 6 V				100	μΑ
IO(OFF)	Output current with power off (see Note 3)	ACC = 0 A	$V_0 = -0.25 \text{ V}$				-100	μΑ
,	Link in a dama a state autout aumant	$V_0 = 2.5 \text{ V}$					20	^
loz	High-impedance-state output current	V _O = 5 V					-20	μΑ
Ι _{ΙΗ}	High-level input current	$V_I = V_{CC}$ or V_{IH}					1	μΑ
I _{IL}	Low-level input current	$V_{I} = GND \text{ or } V_{IL}$				-1	μΑ	
los	Short-circuit output current	VO = VCC or	r GND,	See Note 6	-30		-150	mA
	Complete compart (total paralleles)	No load,	$V_I = V_{CC}$ or (GND		4	6	A
Icc	Supply current (total package)	Enabled	$V_{I} = 2.4 \text{ or } 0.5$	V, See Note 7		5	9	mA
Ci	Input capacitance					6		pF

[†] All typical values are at $V_{CC} = 5 \text{ V}$ and $T_A = 25^{\circ}\text{C}$.

NOTES: 5. Refer to TIA/EIA-422-B for exact conditions.

- 6. Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.
- 7. This parameter is measured per input, while the other inputs are at $V_{\hbox{CC}}$ or GND.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

	PARAMETER TEST CONDITIONS		MIN	TYP†	MAX	UNIT	
tPHL	Propagation delay time, high- to low-level output	$R_1 = R_2 = 50 \Omega$	$R_3 = 500 \Omega$		7	12	ns
tPLH	Propagation delay time, low- to high-level output	$C_1 = C_2 = C_3 = 40 \text{ pF},$	S1 is open,		7	12	ns
t _{sk(p)}	Pulse skew	See Figure 2			0.5	4	ns
t _r	Rise time	$R_1 = R_2 = 50 \Omega$,	$R_3 = 500 \Omega$,		5	10	ns
t _f	Fall time	$C_1 = C_2 = C_3 = 40 \text{ pF},$ See Figure 3	S1 is open,		5	10	ns
^t PZH	Output enable time to high level	$R_1 = R_2 = 50 \Omega,$ $C_1 = C_2 = C_3 = 40 pF,$	$R_3 = 500 \Omega$, S1 is closed.		10	19	ns
tPZL	Output enable time to low level	See Figure 4	31 is ciosed,		10	19	ns
tPHZ	Output disable time from low level	$R_1 = R_2 = 50 \Omega$,	$R_3 = 500 \Omega$, S1 is closed.		7	16	ns
^t PLZ	Output disable time from high level	$C_1 = C_2 = C_3 = 40 \text{ pF},$ See Figure 4	STIS Closed,		7	16	ns

[†] All typical values are at $V_{CC} = 5 \text{ V}$ and $T_A = 25^{\circ}\text{C}$.



RECEIVER SECTION

electrical characteristics over recommended ranges of common-mode input voltage, supply voltage, and operating free-air temperature (unless otherwise noted)

	PARAMETER TEST CONDITIONS		MIN	TYP [†]	MAX	UNIT		
V _{IT+}	Positive-going input threshold ve differential input	oltage,					0.2	V
V _{IT} _	Negative-going input threshold vifferential input	voltage,			-0.2‡			V
V _{hys}	Input hysteresis (V _{IT+} – V _{IT-})					60		mV
VIK	Input clamp voltage, RE	SN75C1167	$I_{I} = -18 \text{ mA}$				-1.5	V
Vон	High-level output voltage		$V_{ID} = 200 \text{ mV},$	$I_{OH} = -6 \text{ mA}$	3.8	4.2		V
VOL	Low-level output voltage		$V_{ID} = -200 \text{ mV},$	I _{OL} = 6 mA		0.1	0.3	V
loz	High-impedance-state output current	SN75C1167	V _O = V _{CC} or GND			±0.5	±5	μА
Ι.	I have been disconnected		Other in and at O.V	V _I = 10 V			1.5	4
l _l	Line input current		Other input at 0 V	V _I = −10 V			-2.5	mA
П	Enable input current, RE	SN75C1167	$V_I = V_{CC}$ or GND				±1	μΑ
rį	Input resistance		$V_{IC} = -7 V \text{ to } 7 V,$	Other input at 0 V	4	17		kΩ
				V _I = V _{CC} or GND		4	6	
ICC	Supply current (total package)		No load, Enabled	V _{IH} = 2.4 V or 0.5 V, See Note 5		5	9	mA

[†] All typical values are at $V_{CC} = 5 \text{ V}$ and $T_A = 25^{\circ}\text{C}$.

NOTE 5: Refer to TIA/EIA-422-B for exact conditions.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 8)

	PARAMETER		TEST CONDITIONS		TYP [†]	MAX	UNIT
^t PLH	Propagation delay time, low- to high-level output	Ca a 5:	_	9	17	27	ns
tPHL	Propagation delay time, high- to low-level output	See Figure	5	9	17	27	ns
tTLH	Transition time, low- to high-level output	.,	O Fi 5		4	9	ns
tTHL	Transition time, high- to low-level output	$V_{IC} = 0 V$	See Figure 5		4	9	ns
tPZH	Output enable time to high level				13	22	ns
tPZL	Output enable time to low level	R _I = 1 kW,	See Figure 6		13	22	ns
tPHZ	Output disable time from high level	KL = 1 KVV,	See Figure 6		13	22	ns
tPLZ	Output disable time from low level				13	22	ns

[†] All typical values are at $V_{CC} = 5 \text{ V}$ and $T_A = 25^{\circ}\text{C}$.

NOTE 8: Measured per input while the other inputs are at VCC or GND



[‡] The algebraic convention, where the less positive (more negative) limit is designated as minimum, is used in this data sheet for common-mode input voltage and threshold voltage levels only.

PARAMETER MEASUREMENT INFORMATION

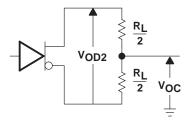
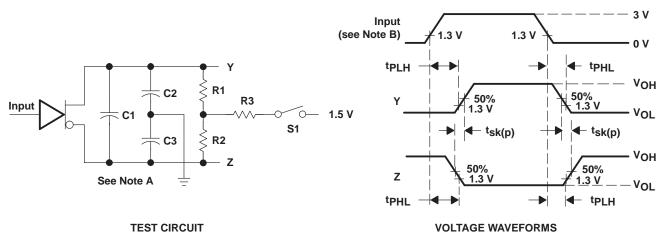


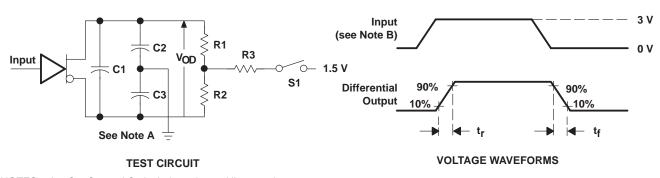
Figure 1. Driver Test Circuit, VOD and VOC



NOTES: A. C1, C2, and C3 include probe and jig capacitance.

B. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, duty cycle = 50%, $t_r = t_f \le 6$ ns.

Figure 2. Driver Test Circuit and Voltage Waveforms

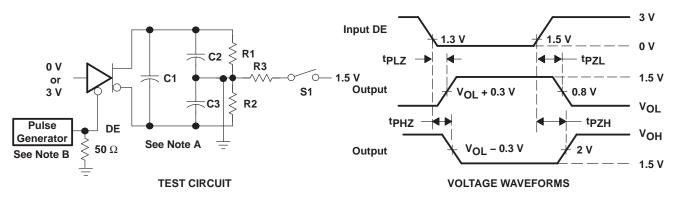


NOTES: A. C1, C2, and C3 include probe and jig capacitance.

B. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, duty cycle = 50%, $t_{\Gamma} = t_{\tilde{f}} \le 6$ ns.

Figure 3. Driver Test Circuit and Voltage Waveforms

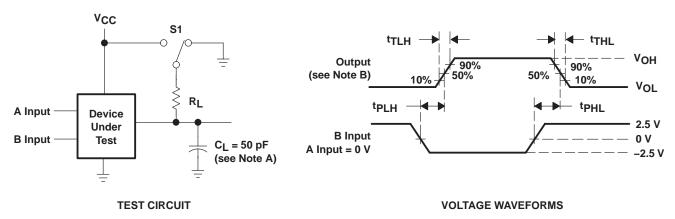
PARAMETER MEASUREMENT INFORMATION



NOTES: A. C1, C2, and C3 include probe and jig capacitance.

B. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, duty cycle = 50%, $t_f = t_f \le 6$ ns.

Figure 4. Driver Test Circuit and Voltage Waveforms



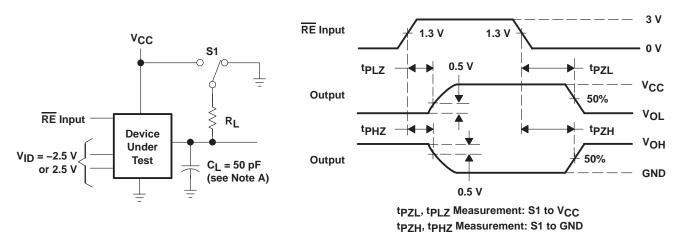
NOTES: A. C_L includes probe and jig capacitance.

B. The pulse generator has the following characteristics: PRR \leq 1 MHz, duty cycle = 50%, $t_f = t_f \leq$ 6 ns.

Figure 5. Receiver Test Circuit and Voltage Waveforms

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PARAMETER MEASUREMENT INFORMATION



VOLTAGE WAVEFORMS

NOTES: A. C_L includes probe and jig capacitance.

TEST CIRCUIT

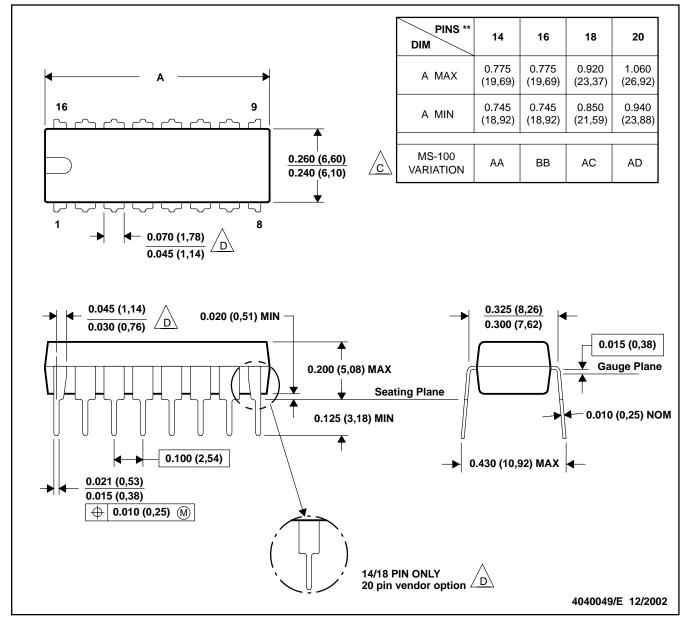
B. The pulse generator has the following characteristics: PRR \leq 1 MHz, duty cycle = 50%, t_Γ = $t_f \leq$ 6 ns.

Figure 6. Receiver Test Circuit and Voltage Waveforms

N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

Falls within JEDEC MS-001, except 18 and 20 pin minimum body Irngth (Dim A).

The 20 pin end lead shoulder width is a vendor option, either half or full width.

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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